IRF540

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.077

100

72

11

32

Single

 $V_{GS} = 10 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF540PbF
Lead (Pb)-free and halogen-free	IRF540PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	100	v	
Gate-source voltage			V _{GS}	± 20	v	
	V + 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		28		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	ID	20	A	
Pulsed drain current ^a			I _{DM}	110		
Linear derating factor				1.0	W/°C	
Single pulse avalanche energy ^b			E _{AS}	230	mJ	
Repetitive avalanche current ^a			I _{AR}	28	A	
Repetitive avalanche energy ^a			E _{AR}	15	mJ	
Maximum power dissipation	T _C =	25 °C	PD	150	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	*0	
Soldering recommendations (peak temperature) ^d	For 10 s			300	°C	
Mounting torque	6-32 or M3 screw			10	lbf · in	
				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 440 μ H, R_g = 25 Ω , I_{AS} = 28 A (see fig. 12)

c. $I_{SD} \le 28$ A, dl/dt ≤ 170 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS						
PARAMETER	SYMBOL	TYP.	MAX	ζ.		UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50 -			°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	1.0				
		1					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	rise noted)					
PARAMETER	SYMBOL		CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	ł	4			Į	<u>I</u>	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	o 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V	_{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _G	_S = ± 20 V	-	-	± 100	nA
Zaus ante colta se ducia como et		V _{DS} = 1	00 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 80 V, V	_{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 17 A ^b	-	-	0.077	Ω
Forward transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 17 A ^b	8.7	-	-	S
Dynamic	•			•	•	•	•
Input capacitance	C _{iss}	V	_{GS} = 0 V,	-	1700	-	
Output capacitance	C _{oss}	V	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		560	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0	VHz, see fig. 5	-	120	-	
Total gate charge	Qg			-	-	72	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 17 A, V _{DS} = 80 V, see fig. 6 and 13 ^b	-	-	11	nC
Gate-drain charge	Q _{gd}		see lig. 0 and 15	-	-	32	
Turn-on delay time	t _{d(on)}		·	-	11	-	- ns
Rise time	t _r	$V_{DD} = $	50 V, I _D = 17 A	-	44	-	
Turn-off delay time	t _{d(off)}		$_{0}$ = 2.9 Ω , see fig. 10 ^b	-	53	-	
Fall time	t _f			-	43	-	
Gate input resistance	R _g	f = 1 M	Hz, open drain	0.5	-	3.6	Ω
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal source inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the		-	-	28	
Pulsed diode forward current ^a	I _{SM}	integral rever p - n junction c		-	-	110	A
Body diode voltage	V _{SD}	T _J = 25 °C, Is	$_{\rm S}$ = 28 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T 25 °C I -	17 A, dl/dt = 100 A/µs ^b	-	180	360	ns
Body diode reverse recovery charge	Q _{rr}	1J=23 0, IF=	π , μ , μ = 100 A/ μ S ⁵	-	1.3	2.8	μC
Forward turn-on time	t _{on}	Intrinsic turn	-on time is negligible (tu	rn-on is do	minated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

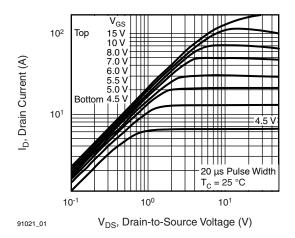


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

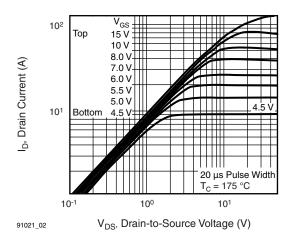
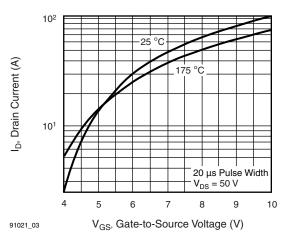


Fig. 2 - Typical Output Characteristics, $T_C = 175 \ ^\circ C$





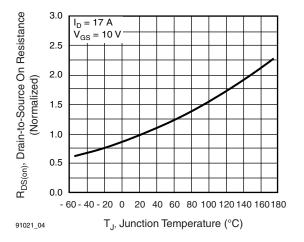


Fig. 4 - Normalized On-Resistance vs. Temperature

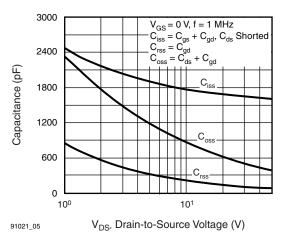


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

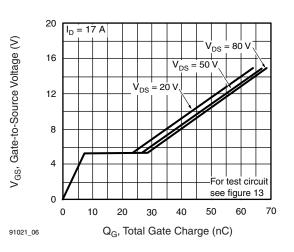


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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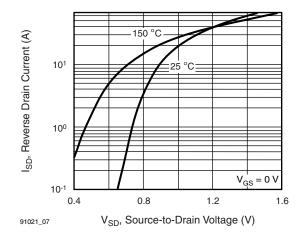


Fig. 7 - Typical Source-Drain Diode Forward Voltage

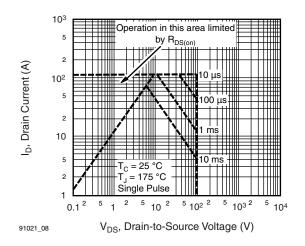


Fig. 8 - Maximum Safe Operating Area

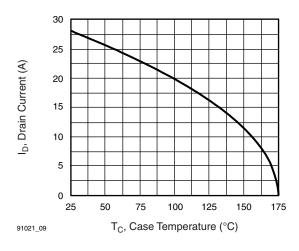


Fig. 9 - Maximum Drain Current vs. Case Temperature

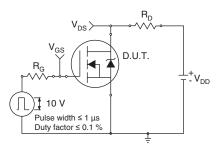


Fig. 10a - Switching Time Test Circuit

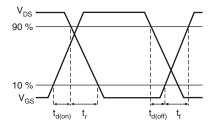


Fig. 10b - Switching Time Waveforms

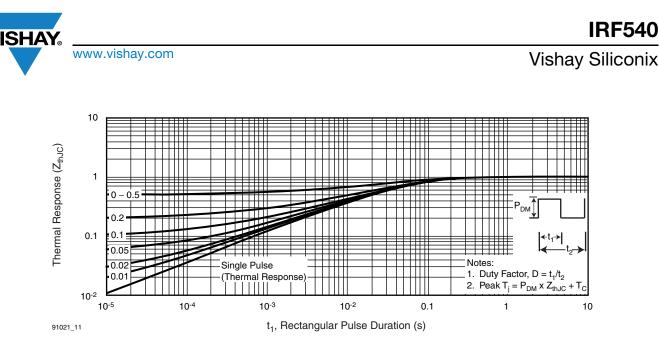


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

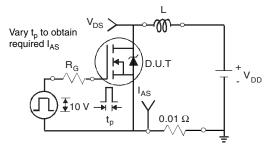
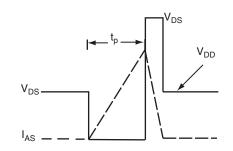
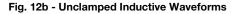


Fig. 12a - Unclamped Inductive Test Circuit





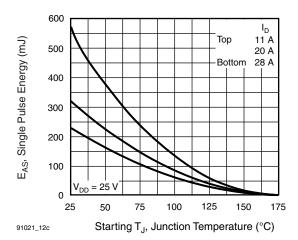


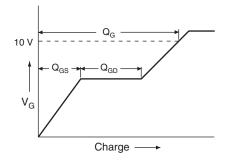
Fig. 12c - Maximum Avalanche Energy vs. Drain Current

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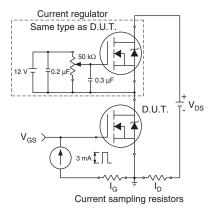


Fig. 13a - Basic Gate Charge Waveform



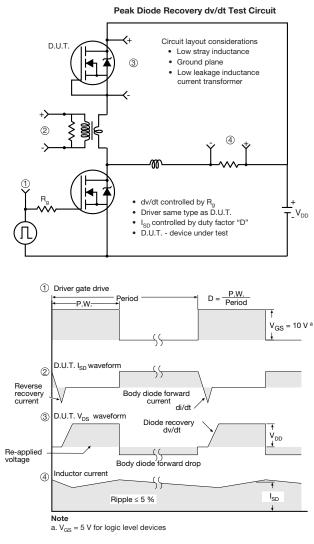


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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